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10/594,844	SERIAL NUM	IBER FILING or 371(c)				CLASS GROUP			ART UNIT ATTO		RNEY DOCKET	
APPLICANTS Akira Ohuchi, Tokyo, JAPAN; Tomoo Murakami, Tokyo, JAPAN; Tomoo Murakami, Tokyo, JAPAN; ***CONTINUING DATA This application is a 371 of PCT/JP2005/000226 01/12/2005 ***FOREIGN APPLICATIONS**** JAPAN 2004-094309 03/29/2004 ***IF REQUIRED, FOREIGN FILING LICENSE GRANTED *** 06/30/2008 Foreign Priority claimed	10/594,84				257			2826				
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